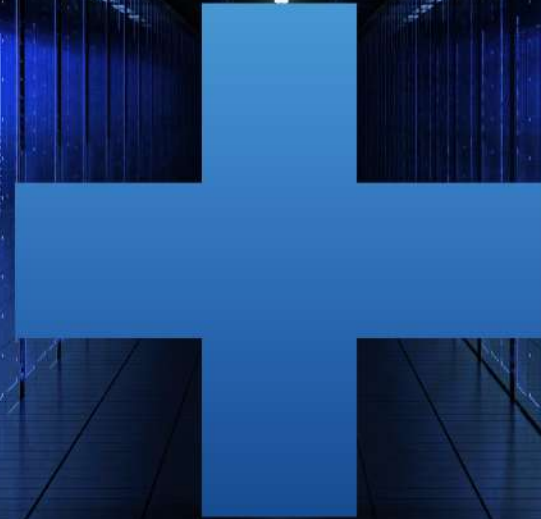




DATACENTER FORUM  
STOCKHOLM 2025  
DATACENTER FORUM  
**STOCKHOLM**

2025

DECEMBER  
04

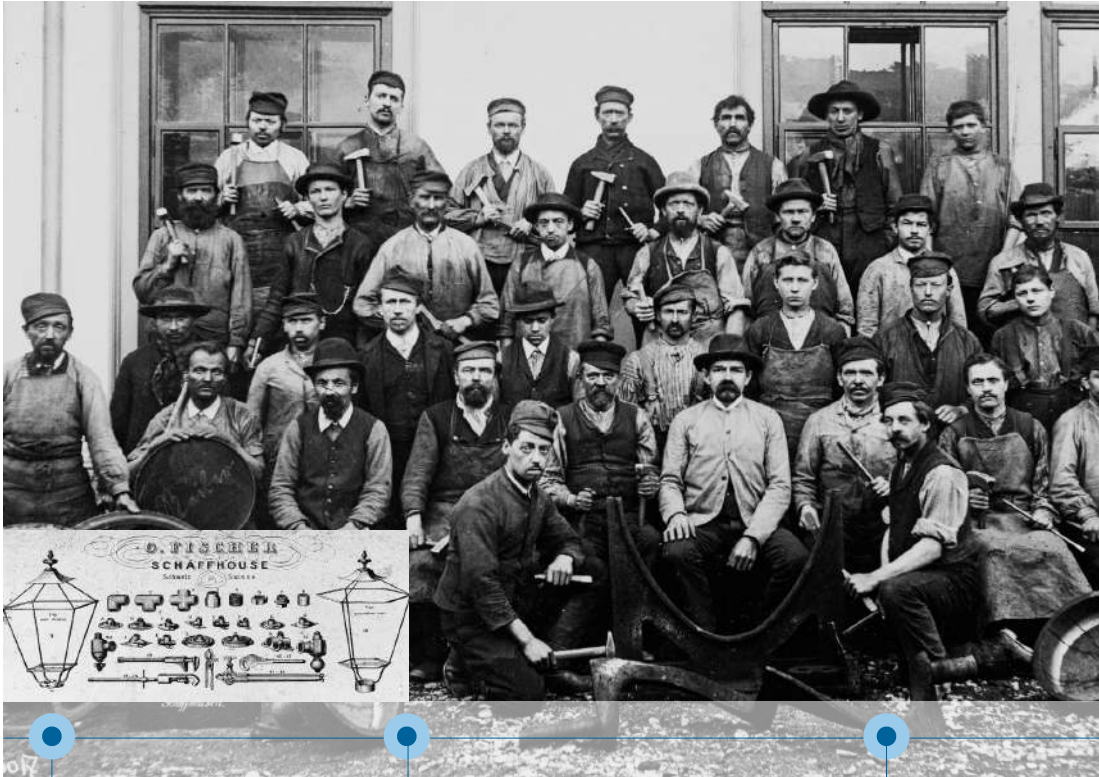


# GF Flow Solutions for Data Centers

## LiquidCore : Polymer Piping for DLC



# Innovating flow solutions since 1802



## 1802 – Foundation

Our first major innovation was a fitting.

## 19<sup>th</sup> Century

Scaling foundry operations and expansion into steel and high-precision components.

## Early 20<sup>th</sup> Century

Automated production and standardized piping systems.

## Late 20<sup>th</sup> Century

Thermoplastics and welding technology, new type joints.

## 2000s

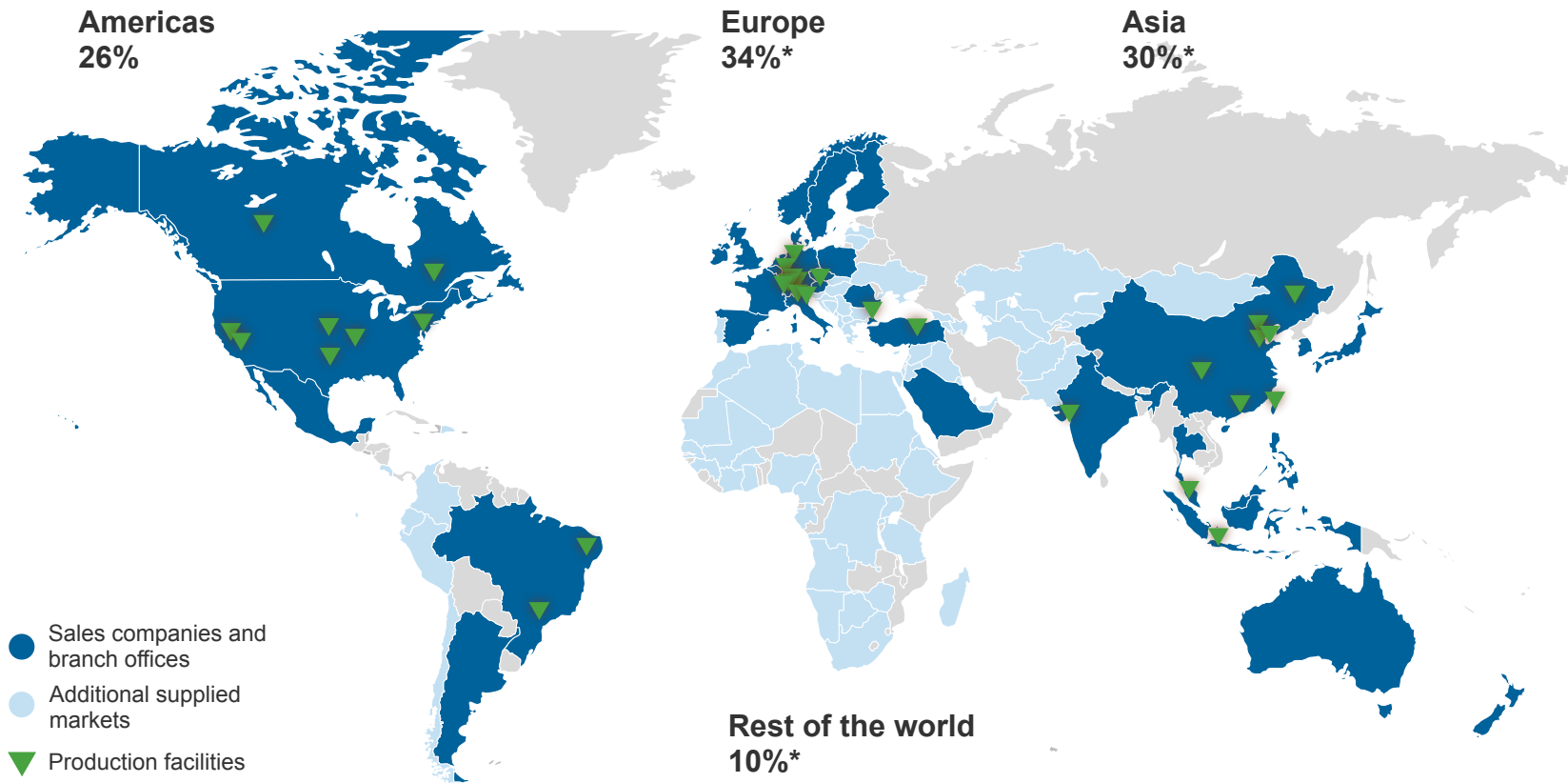
High purity solutions, Digitalization and sustainability initiatives.





# GF is present across the globe

## GF Industry and Infrastructure Flow Solutions



## GF Corporation

**+ CHF 4.8 bn**

Sales 2024

**+ 19'023**

Employees worldwide

**+ 184**

Total locations

**+ 46**

Countries

\*Key figures based on the financial year 2024

# #1 in engineered industrial flow solutions

**Sales** (2024 pro-forma new structure)

**CHF ~1'100 million**

## Competitive advantage

- Customized and prefabricated solutions
- Unique know-how in material, engineering and automation of flow processes
- Global presence and service levels

## Customers



## Key segments



Semiconductors



Chemical Process



Water Industry



Marine



Data Center



Food and Beverage



Energy



Life Sciences



PVDF / ECTFE



Pre-insulated pipes



PP



PVC



Valves



Actuators



Measurement



# GF offers widest variety of non-corrosive plastic piping solutions



**ecoFIT**



**PVC-U**



**PVC-C**



**PROGEF Standard & Plus**



**PROGEF Natural**



**SYGEF Standard & Plus**

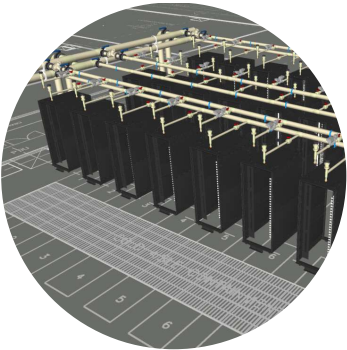


**SYGEF ECTFE**



**ELGEF Plus**

# From design to operation, we support the entire construction process and beyond



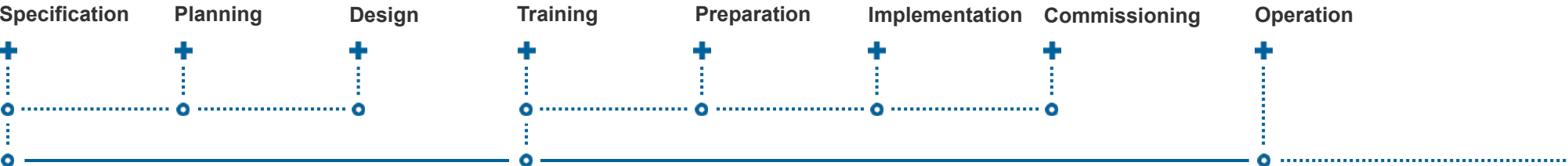
**Design and engineering services**  
We support engineering and design at the front end of a project



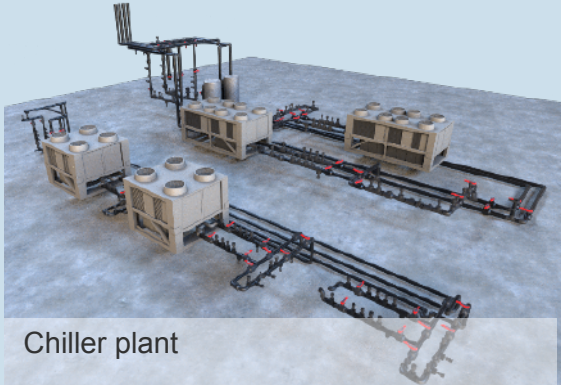
**Pre-fabrication production facilities, channel sales, and installation training**  
We pre-fabricate systems and modules in our 16 prefabrication hubs and deliver them directly to construction sites



**Lifecycle support**  
We partner with OEMs and EPCs throughout the lifetime of their construction projects



# + Facility and Process Waters ... a long history of Mission Critical Projects >25yrs



Thermal Walls   AHUs   Evaporative Cooler   Chillers   Water Cooled Condensers   Dry Cooler   Cooling Towers   Heat Pumps

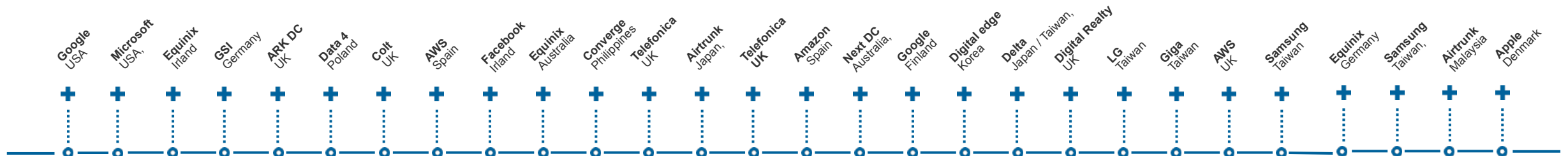
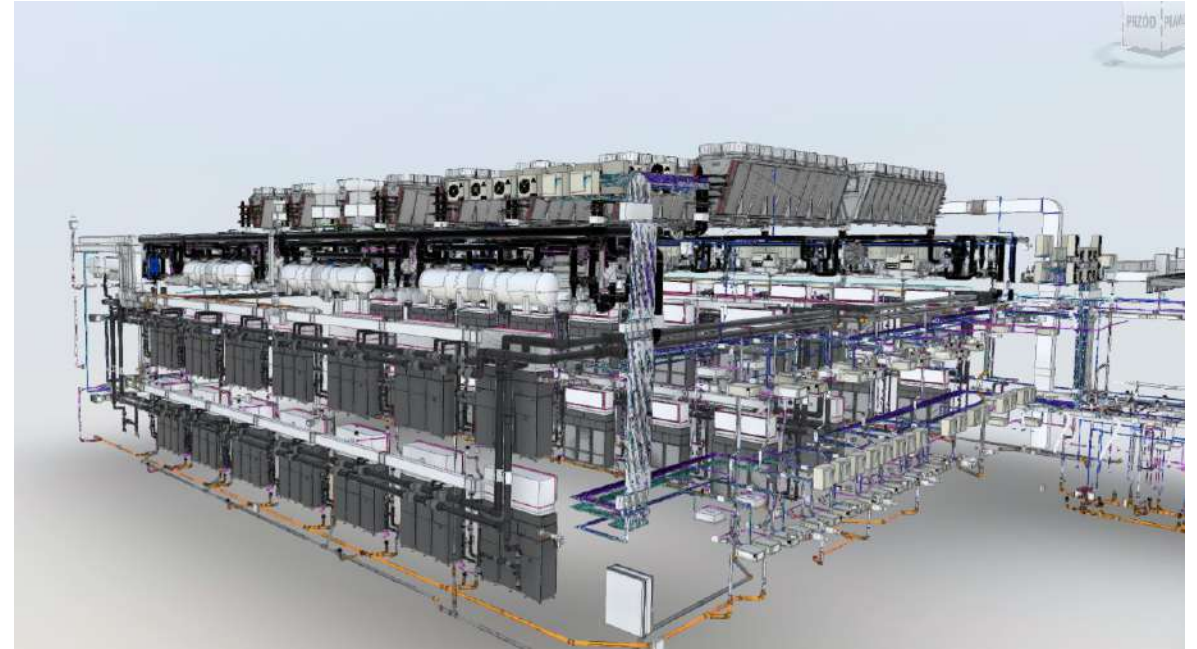
- Chilled Water
- Condenser Water
- Industrial Water
- Chemical Water Treatment
- Process water
- Make Up and Domestic Water
- Drainage and Condensate
- Waste Heat Recovery
- Facility Water (from CDU or Immersion)

## GF covers

### Operating conditions:

- -40°C to +80°C (+140°C)
- DN10-1000mm
- PN 16
- Indoors and outdoors

# + We have a long history and successful track record realising Mission Critical Facilities





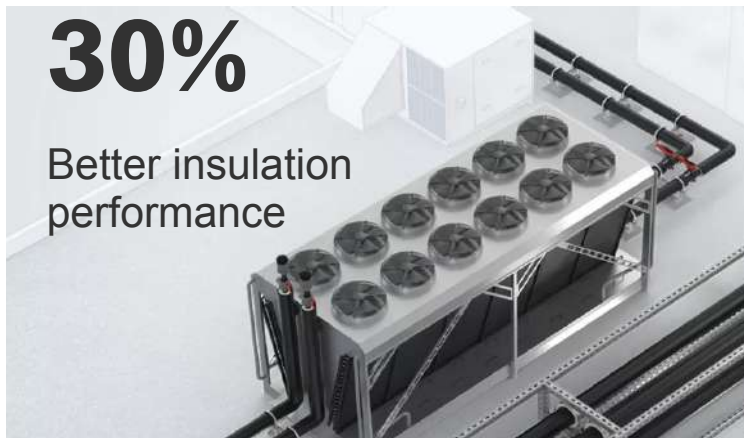


Engineered for Data Centers

# Polymer Piping Delivers Value

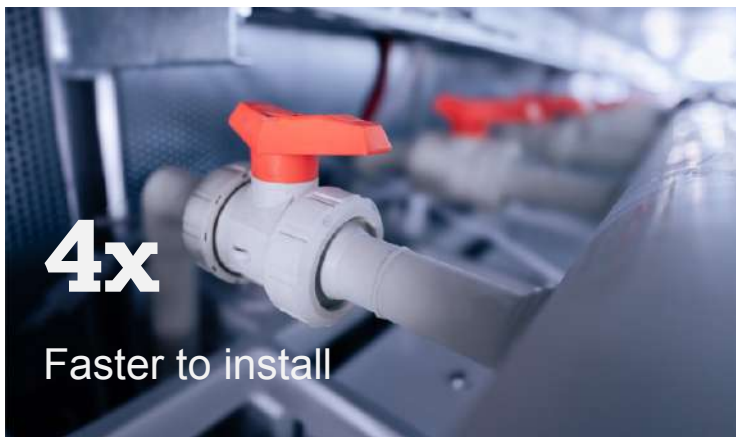
**30%**

Better insulation  
performance



**4x**

Faster to install



**50%**

Lighter than  
metal



**100%**

Corrosion-free



**100%**

Peace of mind



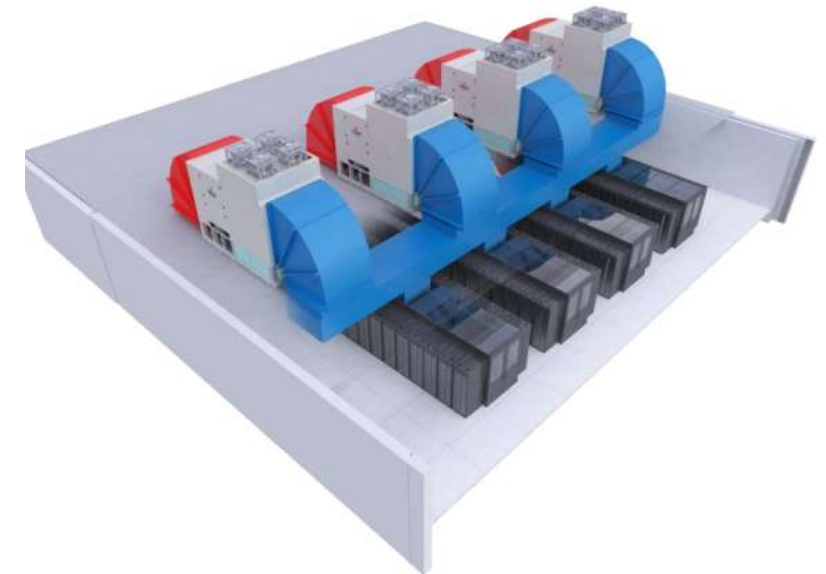
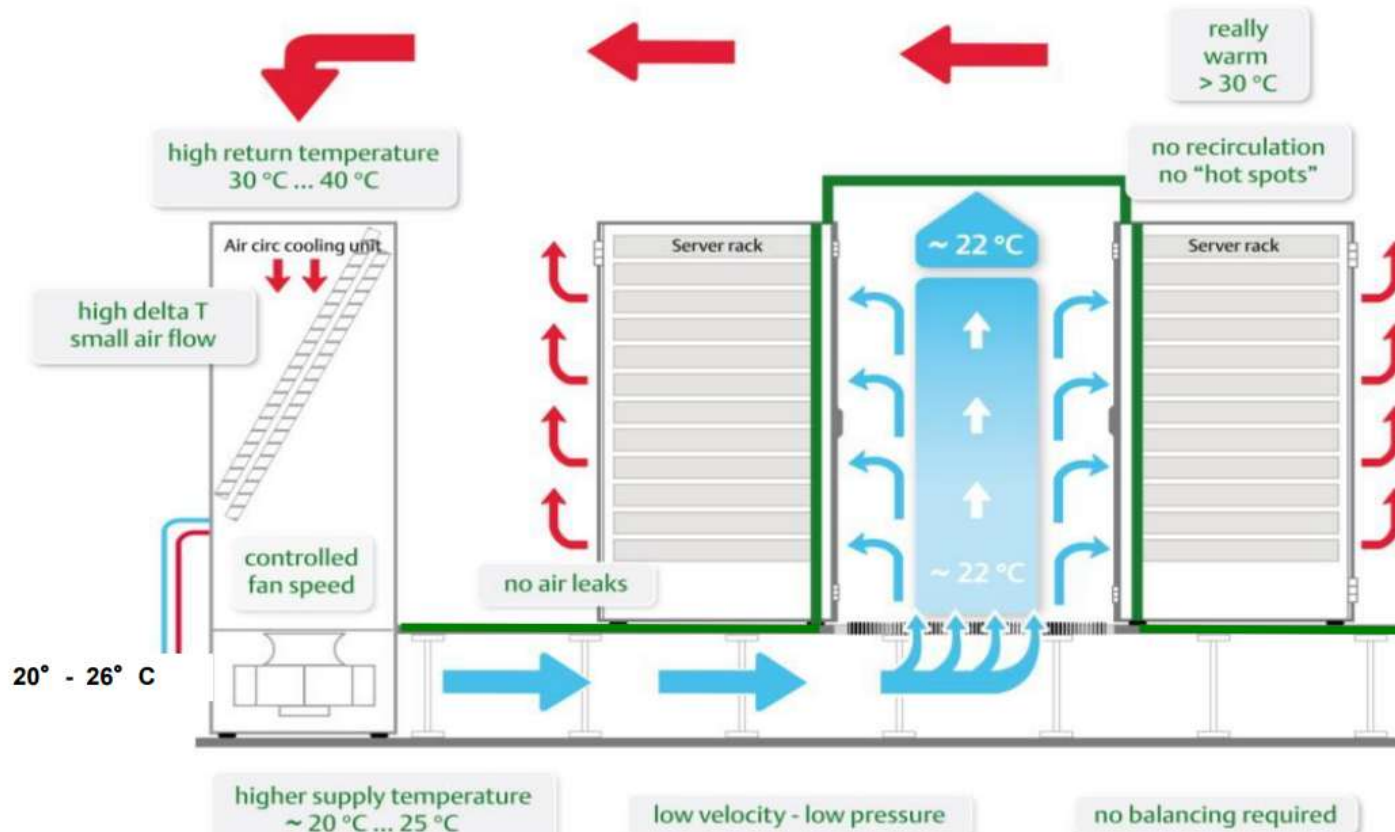
**80%**

Lower  
CO<sub>2</sub>  
footprint



# + Data Center Cooling

was and still will be with air, but transition to liquid is happening

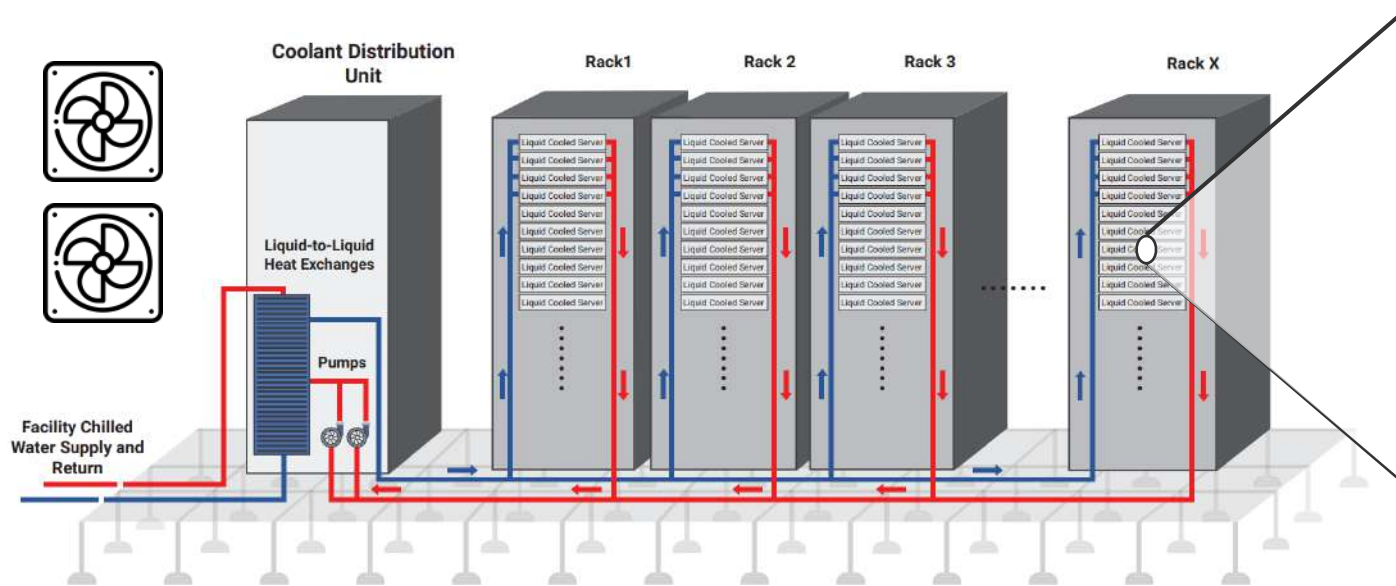


CRAC, CRAH  
Roof-Top , External  
**Air cooling** the servers in the racks

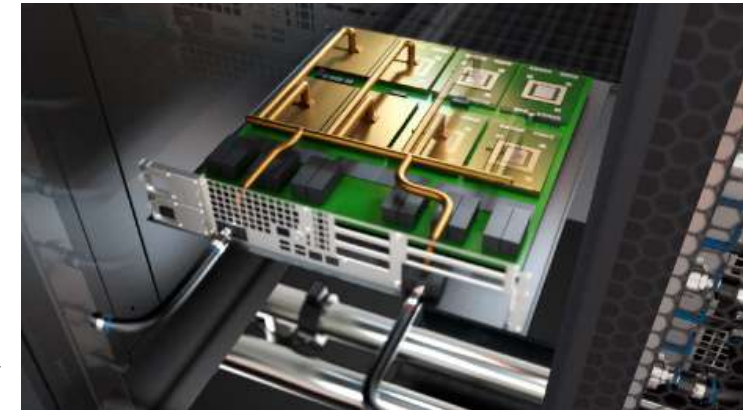
# + New Data Centers designs will be hybrid 80% Liquid Cooled: 20% Air Cooled

## Design Criteria :

- Hybrid of air-cooled and hybrid air/liquid cooled racks
- Liquid cooling infrastructure to be sized for **95%** of the IT equipment
- Air cooling infrastructure to be sized for **44%** of the IT equipment
- AHU's designed for **44%** of IT Capacity

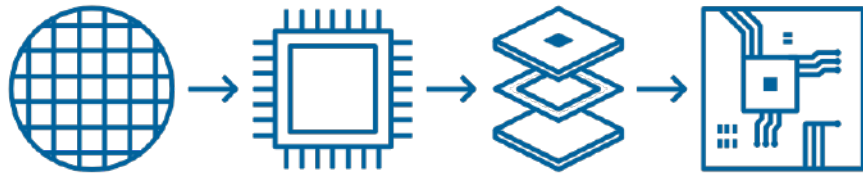


Liquid cooling for GPUs / CPUs 80% of heat generated





# Over 30 years in Microelectronics: Trusted in the frontline of the world's most valuable chips



**1 per trillion**  $(10^{12})$   
impurity particles

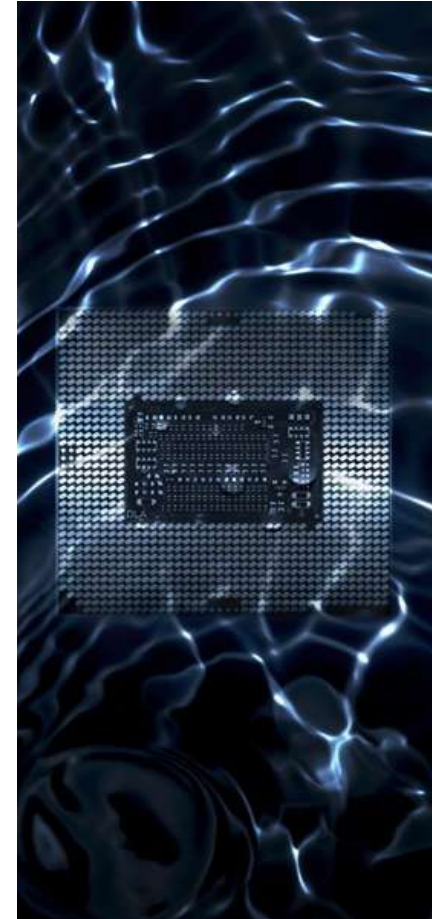
constant innovation, ensuring  
to stay ahead of industry.



Multiple Supply Excellence Awards, latest 2025.

**200+**  
**Wet processes**

Majority of semiconductor manufacturing  
processes rely on ultrapure water (UPW).



# **GF is solution provider for applications requiring absolute reliability and purity**



**+** Water purification systems



**+** Chemical Conveyance



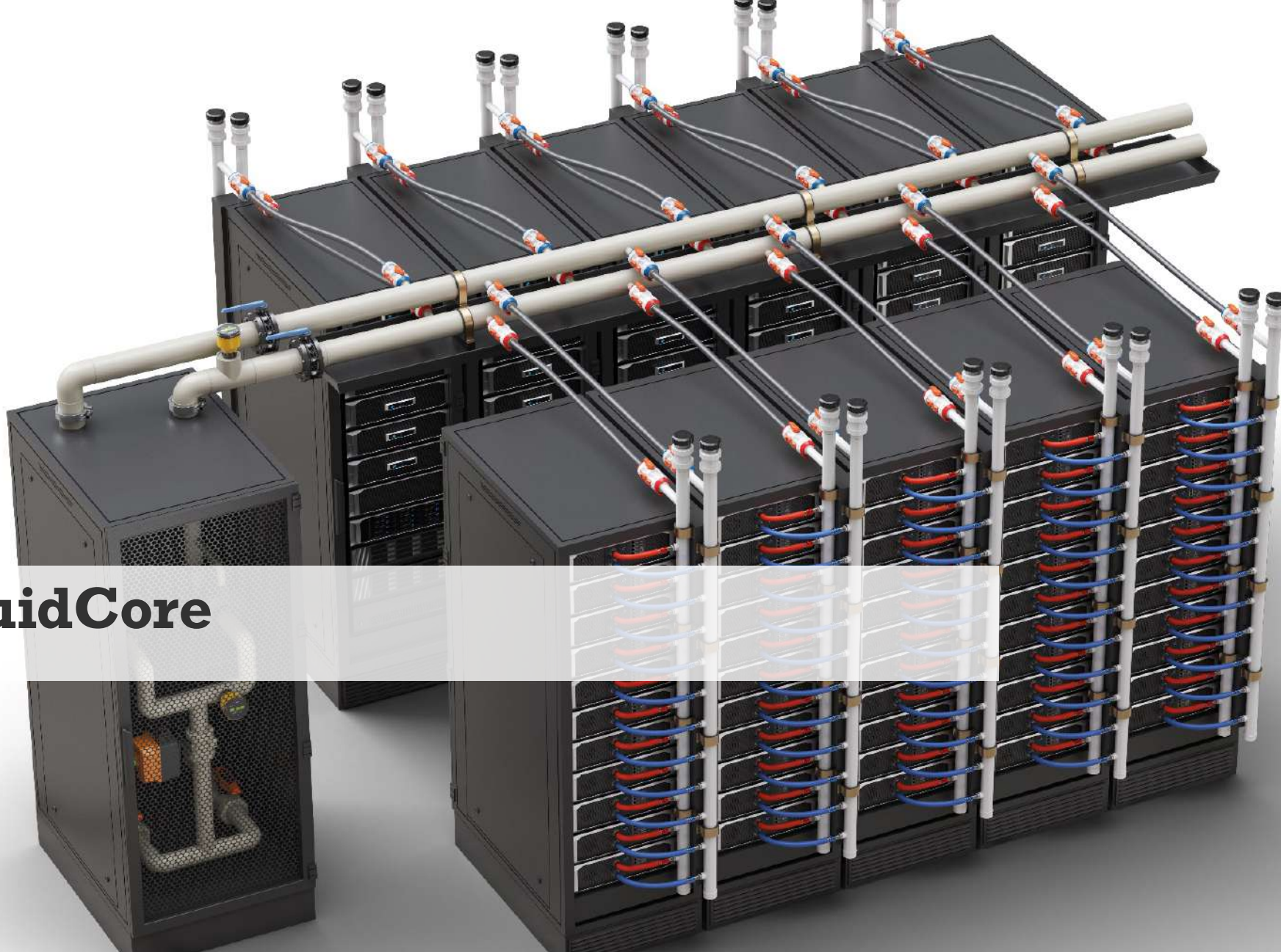
**+** Ultrapure Water delivery



**+** Treatment and control



# GF LiquidCore





# Plug-and-play connection to cooling pipelines



## Patented dual interlock valve

With lever mechanism that prevents accidental decoupling.



## 55% less weight

From 1.8kg to 0.8kg, with same strength, performance, and reliability



## 25% better flow

Full-bore valve design for optimal flow and reduced pressure drop



## Easy handling

Safe, easy, and ergonomic to handle and color coding for supply/return lines.



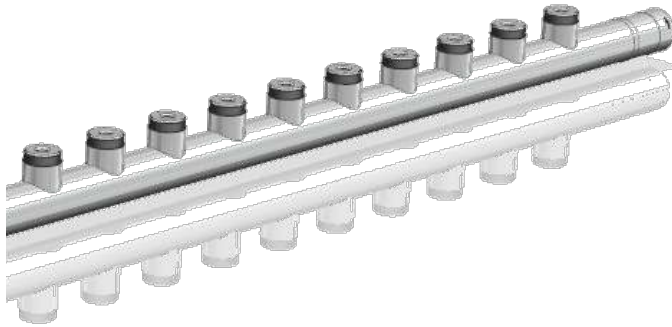
## 100% reliable

Corrosion-free, proven design, and thoroughly tested for long service life.

## Environmental Product Declaration



# Bespoke Manifold Design for Uniform Coolant Flow and Optimal Performance



**Consistent coolant Flow**



## 100% Design Flexibility

Open design, compatible with variety of UQDs, possible to customize.



## 100% Quality Tested

Visual inspection and pressure test for every product before delivery.



## 100% Reliability

Non-metallic materials for long-lasting, high-performing solution.



## 50% Less Weight

Significantly lower weight than metal without compromising on quality or reliability



Outlet 1 : 2.2 l/min  
Outlet 10 : 2.4 l/min  
Outlet 25 : 2.4 l/min

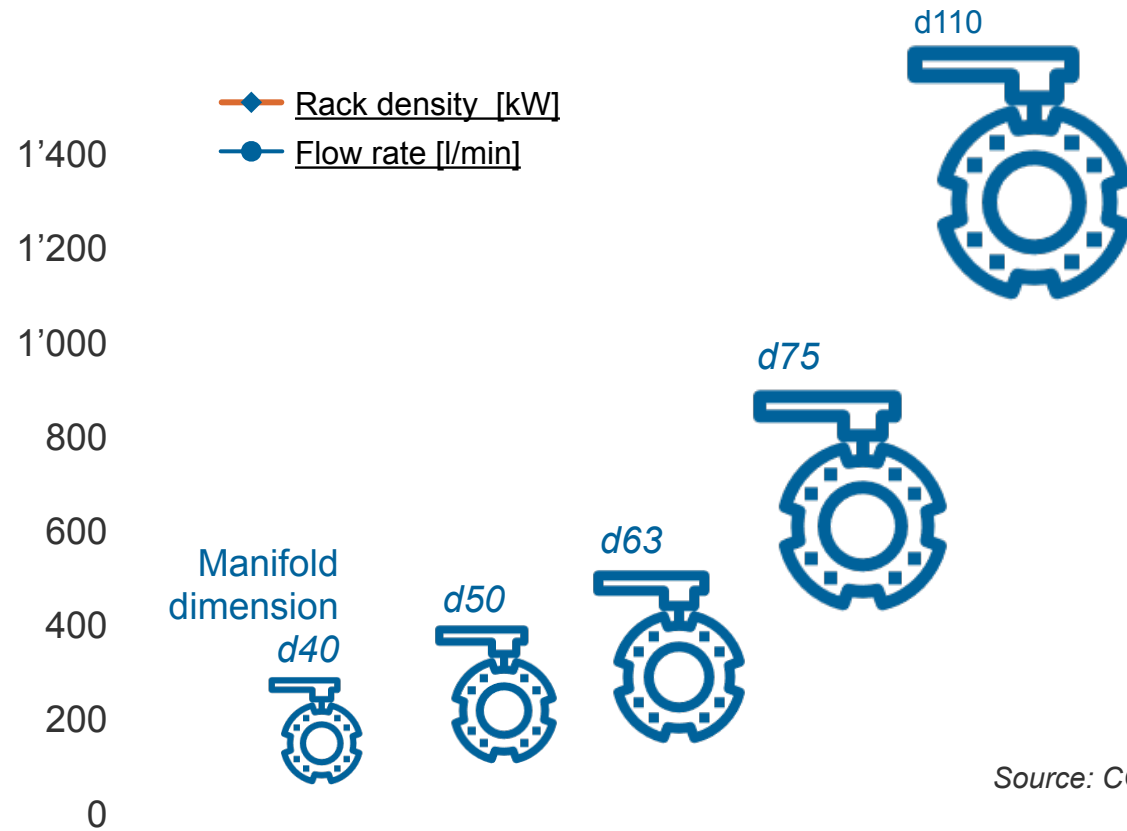
# + AI Rack Densities Future Proofing Infrastructure : A Challenge

..... +  
**Larger dimensions**  
to facilitate the flow

..... +  
**Weight**  
becoming critical design factor

..... +  
**Installation**  
increasing challenges

Rising rack power density is driving the scaling up flow

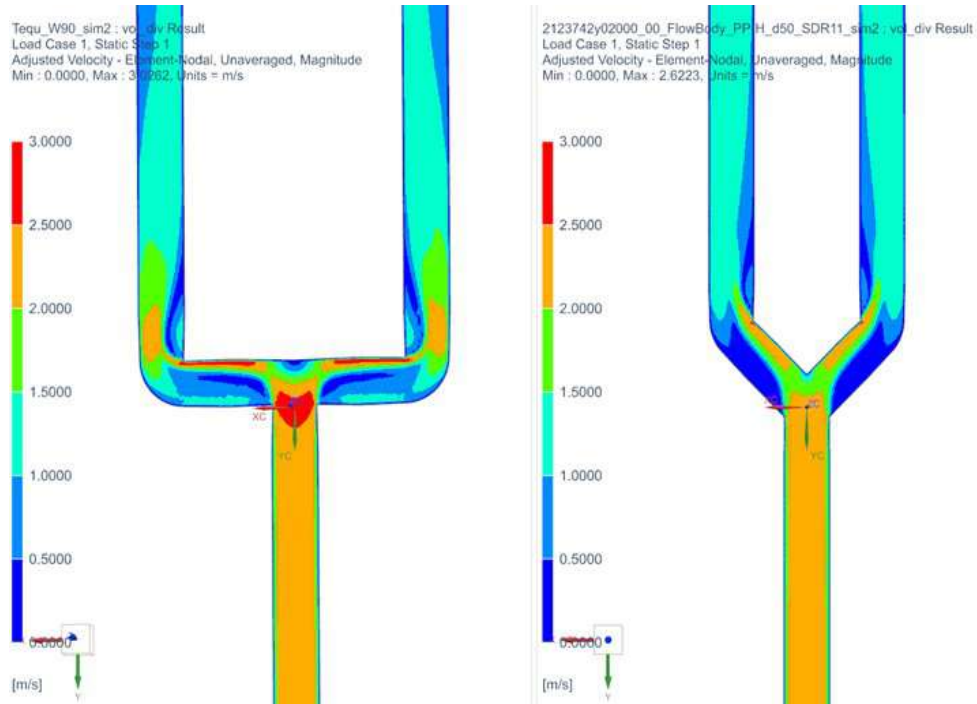


Source: COOL-IT



# + By mastering flow, we optimize the system performance

## Piping system performance optimized by design



Source: GF Flow Solutions

- ..... + **Efficiency**  
Reduced complexity
- ..... + **Power consumption**  
Minimized pressure drop
- ..... + **Performance assured**  
Designed to match the requirement

# + Keep the Cold Plate Clean : Priority No. 1



Microsoft has demonstrated a way to cool silicon chips using microfluidics etched in the silicon that allow cooling liquid to flow directly onto the chip.

- Water is a better heat carrier and requires less energy to pump.
- Water is very corrosive to steels.
- Clean Cold Plate is priority – avoid any potential risk of contamination with particles

Source: [Microsoft](#)

## PG 25

..... +

Water potentially as coolant instead of PG25  
We work with PG manufs to Jointly test PG with GF LiquidCore

..... +

## Fluid purity

becoming critical for maintaining the performance

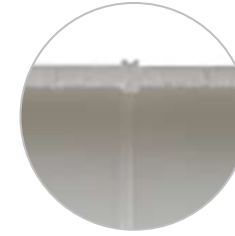
# + Reliable welding is the foundation of leakage-proof cooling installations

## ..... + Molecular bond

Restoring original pipe strength



..... +



..... +



## ..... + Smart Automation

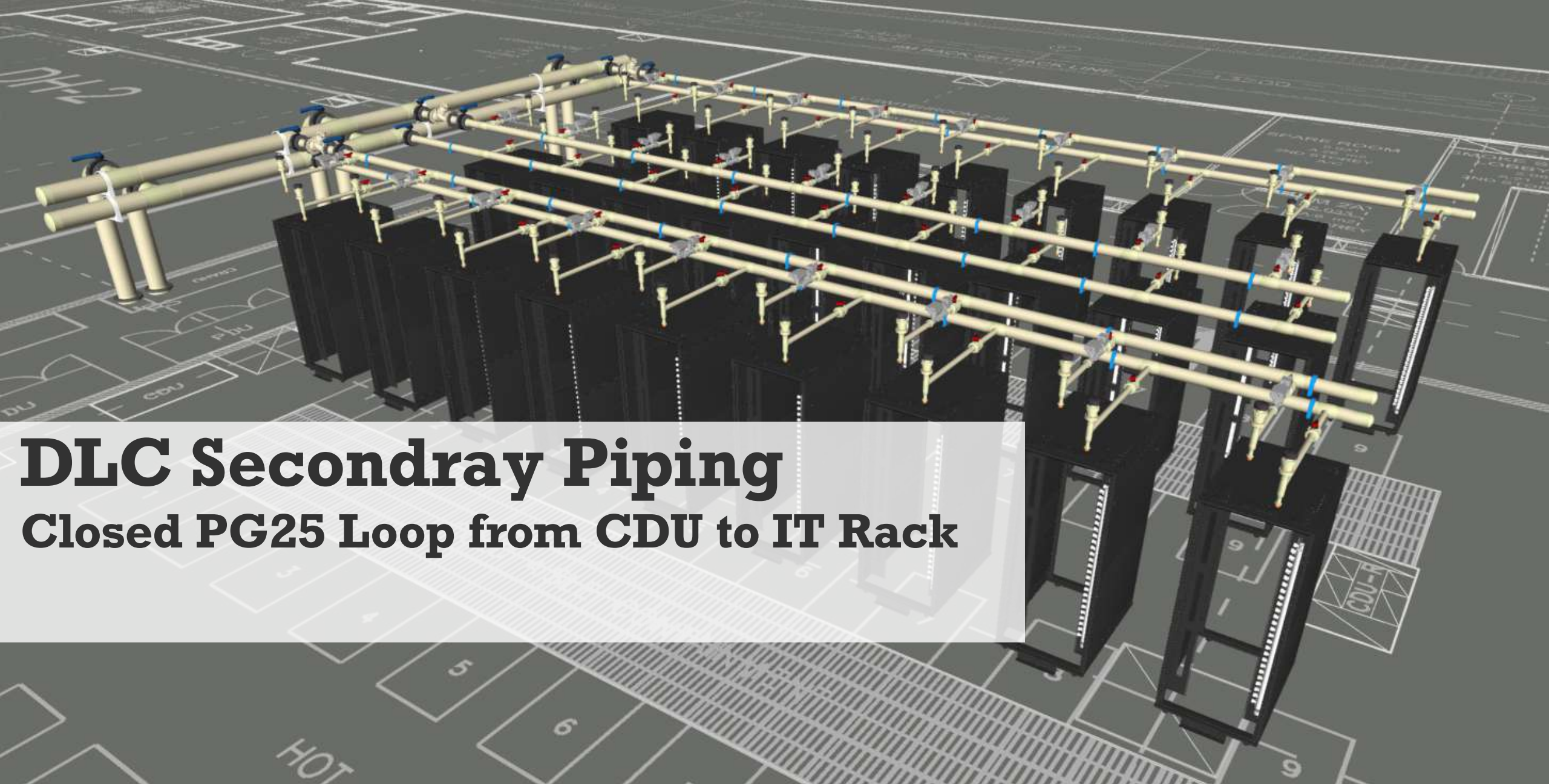
precision without human slip-ups.

## ..... + 1+ million welds annually

trusted by the industry







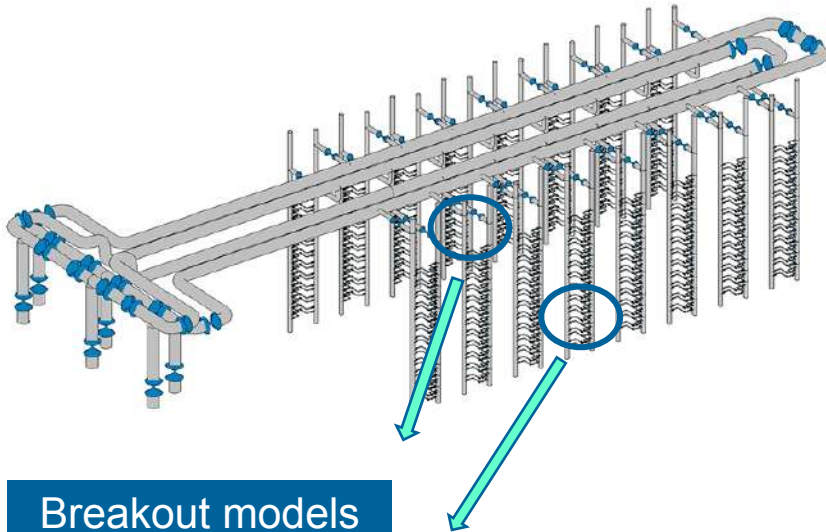
# **DLC Secondary Piping**

## **Closed PG25 Loop from CDU to IT Rack**

# + System Analysis

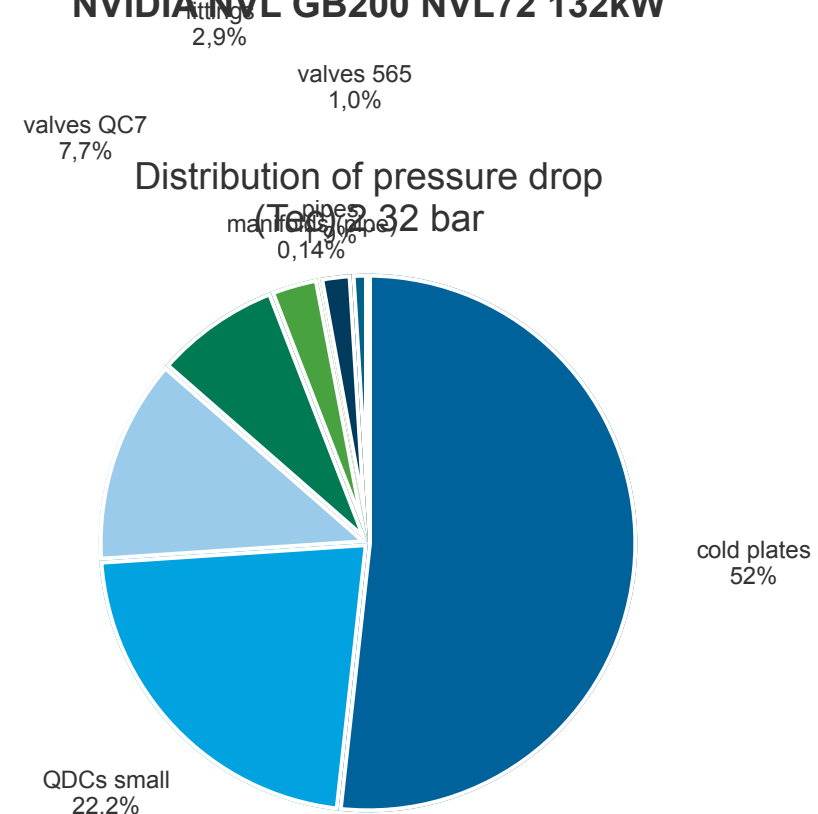
## Pressure Drop 52% in the Cold Plate

Technical loop  
System Level:  
GAE



Breakout models  
Component  
Level: TEC

NVIDIA NVL GB200 NVL72 132kW



Vertiv Liebert XDU 1350kW

- with 1200 l/min
- Pressure drop over filter 0.7 bar
- max pressure drop 2.5 bar

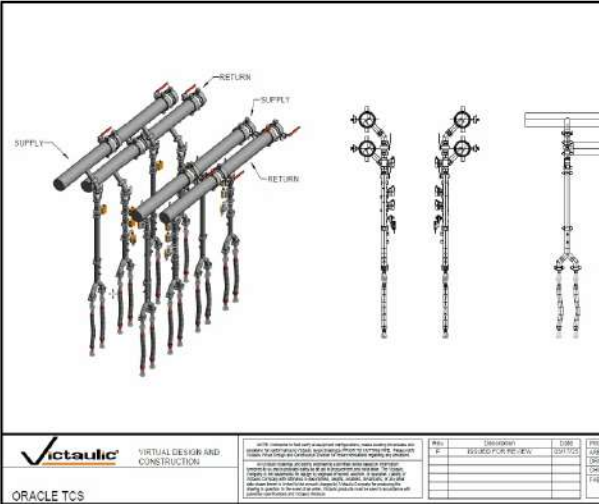
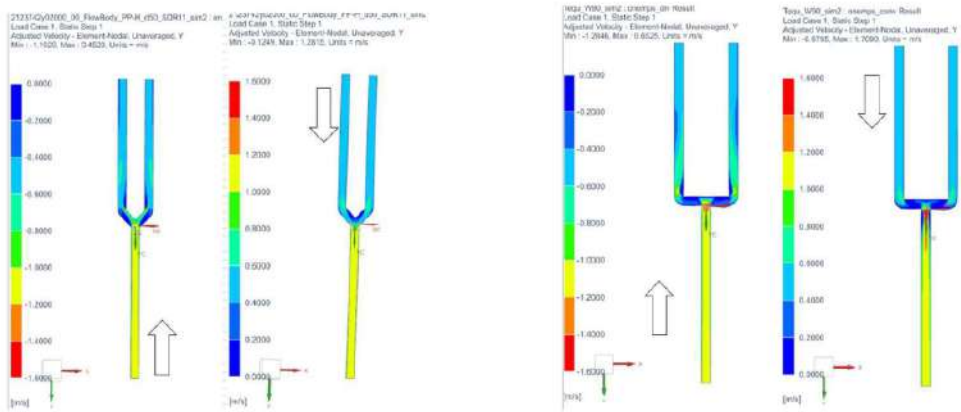


# + Technical water – PG25 Secondary Loop

- End user required pipe layout design support
- End user required support on CFD analysis of custom component
- Commercial and performance evaluation of custom parts

## Modelling review

- Flow velocity evaluation of 45 degree tee with 45 elbows
- Flow velocity evaluation of 90 degree tee with 90 elbows



- 8.15.1 TCS connections shall be arranged such that they connect at high level to the back of the rack. Connections shall be arranged such that the 1" FD83 connections connect to the rack manifold using 90-degree adaptors. Connection points shall be arranged in the vertical. Final connection configuration to be finalized with Owner during design development.
- 8.15.2 There shall be an air vent at the top of each of the distribution manifolds. A drain shall be provided at the low point.

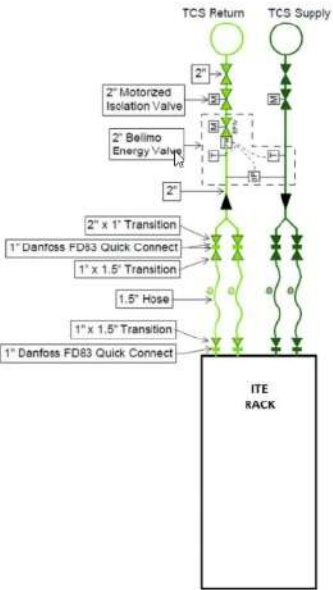
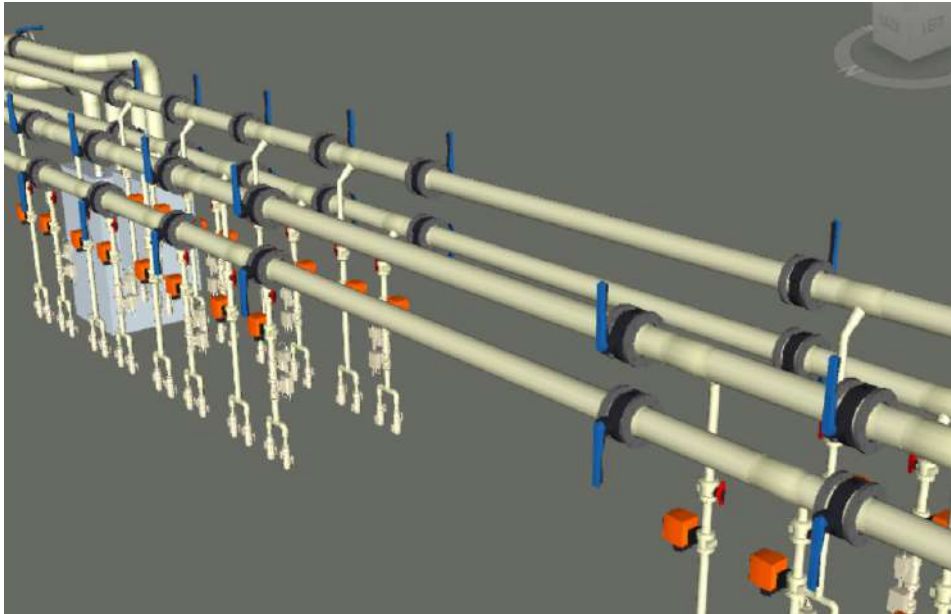


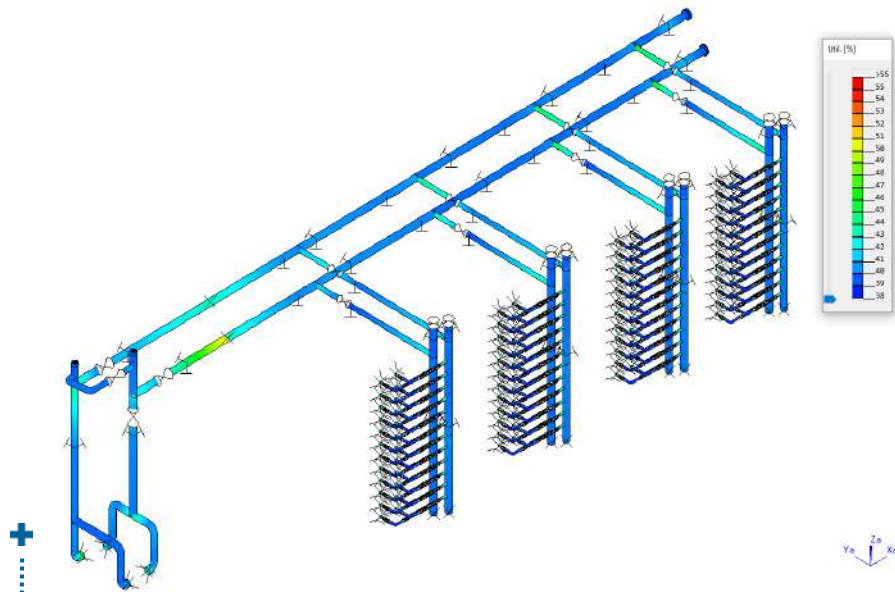
Figure 7: Typical ITE Rack Pipework Connection Detail 1



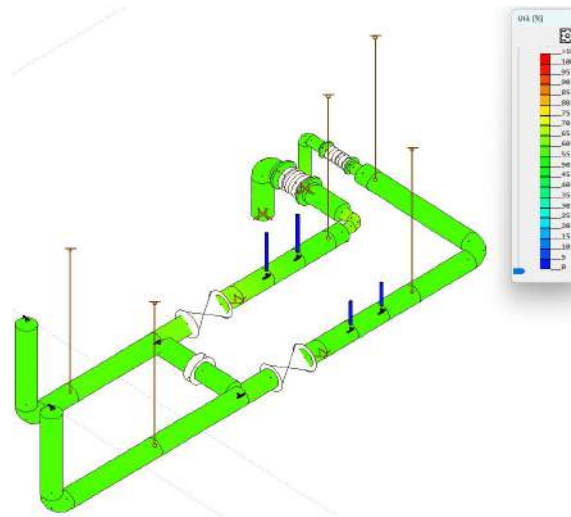


# + GF Engineering Support from Polymer Experts

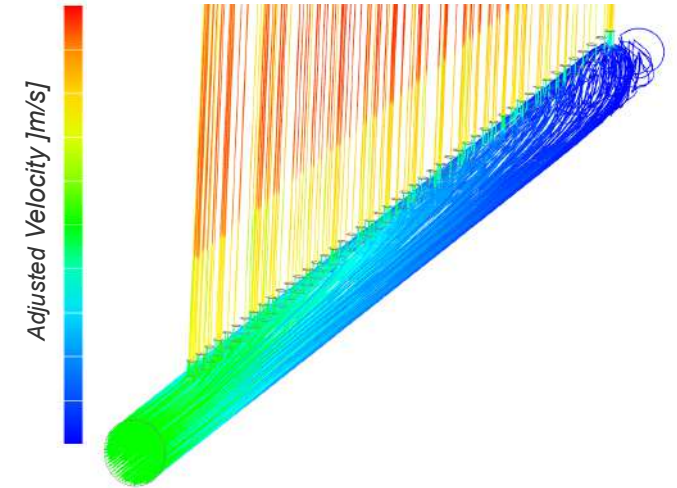
## Pipework Layout, Dimensioning, Exp./Contraction



**System level flow and stress analysis**



**Pipe support concept for safe installations**



**Validated performance**

# +GF+ Engineering Report

<b>+GF+</b>		Georg Fischer Piping Systems Ltd.			
Project US Hyperscale Datacenter		Rev. 1	Page 1	Page 34	
Title Engineering Services Calculation Report					
Client: Global Endcustomer, US EPC Charles Freda, GFPS					
Created by: Georg Fischer Piping Systems Ltd. Ebnatstrasse 111 CH - 8201 Schaffhausen Switzerland					
Created: 17/03/2023		Approved by: Hanspeter Müller		Created by: Jonas Fleischer	

<b>+GF+</b>		Engineering Services – Calculation Report			
This pipe stress analysis includes the following lines / drawings:					
• Center Line-1 • Center Line-4 • Center Line-7 • Center Line-10		• Center Line-2 • Center Line-5 • Center Line-8		• Center Line-3 • Center Line-6 • Center Line-9	
The following general parameters were considered:					
• Density of medium: 1000.0 kg/m³ / 62.4 lb/ft³					
• Assembly temperature: 20°C / ~70°F (~ambient)					
Various modules and sections are being pre-fabricated in a shop, with an average ambient temperature during fabrication.					
The density of medium is considered for the calculation of the line masses of the pipes. Thermal expansion is calculated due to the difference between assembly temperature and operation temperature.					
Date: 2023-03-17					
Page: 10 of 34					
Rev. No.: 1					

<b>+GF+</b>		Engineering Services – Calculation Report			
6 Recommendations					
6.1 General Recommendations					
• Recommended support spacing (acc. to GFPS Planning Fundamentals), if not outlined differently:					
○ 12" → 12.0' / 3750mm					
○ 10" → 11.5' / 3500mm					
○ 8" → 10.5' / 3200mm					
○ 6" → 9.5' / 2950mm					
○ 4" → 8.5' / 2590mm					
○ 3" → 7.5' / 2286mm					
○ 2" → 6.5' / 1981mm					
○ 1½" → 6' / 1828mm					
○ 1" → 5.5' / 1676mm					
○ ¾" → 5' / 1524mm					
• For outlined supports ~3rd hanger executed with the following is recommended:					
○ Hanger + lateral stop:					
○ Hanger line stop:					
• Movement of all outlined Metraflex V-Loops → min + / - 1.5"					
• Additional valve support recommended for valves. Max. distance within 5 x d from valve to support					
Date: 2023-03-17					
Page: 17 of 34					
Rev. No.: 1					

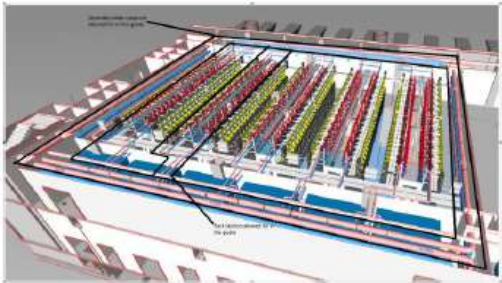
<b>+GF+</b>		Engineering Services – Calculation Report																																																																																			
7.1 Stress Evaluation VGLSR - Equivalent Stress acc. to von Mises																																																																																					
<table><tr><th>Line</th><th>Eq.</th><th>Description</th><th>Load case</th><th>Node</th><th>S-total [psi]</th><th>S-allow [psi]</th><th>Util. [%]</th></tr><tr><td>01</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Dead load</td><td>1019</td><td>286.2</td><td>1020.0</td><td>14.0</td></tr><tr><td>02</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Operator hot</td><td>1058</td><td>192.0</td><td>1878.2</td><td>53.3</td></tr><tr><td>03</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Operator cold</td><td>1021</td><td>230.8</td><td>1971.0</td><td>11.7</td></tr><tr><td>04</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Hot-Empty</td><td>116</td><td>274.0</td><td>1878.2</td><td>48.3</td></tr><tr><td>05</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Cold-Empty</td><td>2716</td><td>166.9</td><td>1878.2</td><td>11.1</td></tr><tr><td>06</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Operator hot+Cr</td><td>1069</td><td>193.4</td><td>1878.2</td><td>53.0</td></tr><tr><td>07</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Operator cold+Cr</td><td>1021</td><td>193.2</td><td>1971.0</td><td>38.3</td></tr><tr><td>08</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Hot-Empty+Cr</td><td>2080</td><td>1724.5</td><td>1878.2</td><td>91.0</td></tr><tr><td>09</td><td>SVM</td><td>Equivalent stress acc. to von Mises</td><td>Cold-Empty+Cr</td><td>1921</td><td>1759.3</td><td>1878.2</td><td>35.0</td></tr></table>						Line	Eq.	Description	Load case	Node	S-total [psi]	S-allow [psi]	Util. [%]	01	SVM	Equivalent stress acc. to von Mises	Dead load	1019	286.2	1020.0	14.0	02	SVM	Equivalent stress acc. to von Mises	Operator hot	1058	192.0	1878.2	53.3	03	SVM	Equivalent stress acc. to von Mises	Operator cold	1021	230.8	1971.0	11.7	04	SVM	Equivalent stress acc. to von Mises	Hot-Empty	116	274.0	1878.2	48.3	05	SVM	Equivalent stress acc. to von Mises	Cold-Empty	2716	166.9	1878.2	11.1	06	SVM	Equivalent stress acc. to von Mises	Operator hot+Cr	1069	193.4	1878.2	53.0	07	SVM	Equivalent stress acc. to von Mises	Operator cold+Cr	1021	193.2	1971.0	38.3	08	SVM	Equivalent stress acc. to von Mises	Hot-Empty+Cr	2080	1724.5	1878.2	91.0	09	SVM	Equivalent stress acc. to von Mises	Cold-Empty+Cr	1921	1759.3	1878.2	35.0
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Load Case Operation Hot																																																																																					
Results stress analysis acc. to VGLSR - Equivalent stresses for pipes: Utilization Analysis S: Equivalent SVM (Equivalent stress acc. to von Mises): Max. utilization 93.3%, node 8088																																																																																					
Figure: Stress analysis, load case operation																																																																																					
According to chapter 2.2 a minimum Safety-Factor of 2.0 is required (industry/ hot water applications).																																																																																					
The maximum ratio of $S_{permissible}/S_{max} = 1878.2 / 1061.0$ [psi] ~2.0																																																																																					
The determined Safety-Factor <u>does meet</u> Georg Fischer Piping Systems' recommendations.																																																																																					
Operation cold is less demanding and therefore not shown.																																																																																					
Date: 2023-03-17		Page: 27 of 34		Rev. No.: 1																																																																																	

+ GF Quote for DLC
Pre-fabricated 1.65m
Spools incl. demarkation
valve



Marked Engelhard
Eggen Central Europe GmbH
L. Swentobogen 55
70576 Stuttgart

Quotation Date: 11.09.2024
Quotation Ref: GFMC-430(5)



Dear Sir

Re: DXYTE\_DLC\_PIPEING\_ML\_2024 - Quotation prepared from model number - DXY-XX-XX-1-54M-XX-1000 - Federated Model (NWC)
PRE-FABRICATED PROJECT PP-01 for rack connection to Primary Ring Main Piping - Main Primary Cooling Loop after CDU is not allowed for, only primary connection from Main Primary loop to rack is allowed for.

Pipe supports not included
The quote is based on a section of 48 racks (24 racks per row) and can be multiplied by the total number of section required
Weld logs have been allowed for and will be provided along with weld maps.
Pressure Testing and/or NDT not considered in quotation
End connections for spools: recommended Electrofusion - not included in quote
Copy of GA (dimension tolerance +/- 2mm) will be provided with each fabrication
EN12201 2.2. Test Certs are allowed for - further material certs, cert of origin etc have not been allowed for and will be charged additionally
Spools are rated to 30 bar @ 20c as shown @ 1.5 safety factor
Welding is quoted as per EN125127 - CNC butt weld and IR
No internal bead removal allowed for
No external bead removal allowed for
Racking rings are quoted currently as PP Steel type PW16 drilling

Table with 7 columns: Code, Description, Quantity, Each, Total, Net plus VAT, and Comments. It lists three items for 'Back Main return from Secondary Cooling Loop - Spool 2' and 'Back Main Flow from Secondary Cooling Loop - Spool 3'.

Summary table for '3) Fabrication against the provided information - Butterfly Valve VSD' and '3) Fabrication against the provided information - Ball Valve Values'. It includes columns for Code, Description, Quantity, Each, Total, and Net plus VAT.

Please ensure our quotation reference is used on any correspondence regarding your quotation.
The take off provided by George Fischer Sales Ltd is indicative of the pipe routes shown on the drawing. It is the responsibility of the installer/purchaser to confirm quantities required to complete the installation.
Changes to drawings will be subject to price review and re-quotation. Please note special items made to customer specifications e.g. fabrications are non-returnable.
Prices are applicable to items and quantities quoted. Any changes may be subject to a price review.
Prices exclude installation, site visits, joining equipment (unless detailed above) & training, nuts, bolts, washers, gaskets, pipe supports, consumables and lubricants. Process design, engineering calculations, O & M manuals, project specific quality plan.
Whilst we make every endeavour to meet all your requirements, we provide our estimate in good faith and GF cannot be held responsible for any inaccuracies contained therein.
Cost includes delivery to GF distributor. Site delivery will be charged additionally.
Order to be placed via a GF distributor of your choice.
This estimate is valid for a period of 30 days from the date of this letter.
George Fischer standard terms and conditions of sale apply, these can be found [here](#).
Assuring you of our best attention at all times.
Yours faithfully,
Ottmar Ahlrich
Estimator & Proposals Engineer - GE Global Industries

Table with 7 columns: Code, Description, Quantity, Each, Total, Net plus VAT, and Comments. It lists five items for 'Back Branch, Flow - 6110 main with 602 branch' and 'Back Main Flow from Secondary Cooling Loop - Spool 1'.





# **GF LiquidCore Complete Polymer DLC Flow Solution**





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04



**Thank You      Questions ? Can we help ?**